

AMENDMENTS TO CLAIMS

This listing of claims will replace all prior versions and listings of claims in this application.

1. (Currently Amended) An input device comprising:
an electrostatic-capacitance-type input sensor including a flexible substrate;
a plurality of X electrodes that are formed on one surface of the flexible substrate and that are disposed on an insulating layer and a plurality of Y electrodes that are disposed on ~~the~~an insulating layer; and
an extension section that is extended from the flexible substrate,
wherein the X and Y electrodes are connected to a non-flexible circuit substrate provided on one surface of the extension section, and the other surface of the flexible substrate of the electrostatic-capacitance-type input sensor is bonded to the reverse surface of a curved portion of a support plate, and the other surface of the flexible substrate of the extension section is bonded to a flattened portion continuously disposed from the curved portion so that an input operation is conducted by performing a ~~bonding~~ contact operation along the obverse surface of the curve portion without viewing the electrostatic-capacitance type input sensor and the circuit substrate from an outer surface.
2. (Original) An electrostatic-capacitance-type coordinate input device according to Claim 1, wherein a recess to which the input sensor is fitted is formed on the rear surface of said support plate at a position where said input sensor is bonded.
3. (Previously Presented) An electrostatic-capacitance-type coordinate input device according to Claim 1, wherein a pointing section for pointing a position of said input sensor is formed in said support plate.
4. - 7. (Cancelled)

8. (Currently Amended) A device, comprising;
an input device having a coordinate-input sensor formed on a flexible substrate and having an electrode layer that includes a plurality of X electrodes and Y electrodes formed on one surface of the flexible substrate for detecting electrostatic capacitance;
a device housing having an insulating portion having obverse and reverse sides, the obverse side being exposed;
wherein the input sensor is disposed on the reverse side of the insulating portion and an input operation is performable at the obverse side,
wherein the coordinate-input sensor has an extension section, a non-flexible circuit substrate to which the electrodes are connected, the non-flexible circuit substrate being disposed on one surface of the extension section, the other surface of the flexible substrate of the input sensor being ~~being~~-bonded to the reverse surface of a curved portion of a support plate, and the other surface of the flexible substrate of the extension section being bonded to a flattened portion of a support plate continuously disposed from the curved portion, so that an input operation is conducted by performing a bonding ~~bonding~~ contact operation along the obverse surface of the curve portion without viewing the electrostatic-capacitance type input sensor and the circuit substrate from an outer surface.

9. (Previously Presented) The device according to claim 8, wherein the input sensor is bonded to an arcuate section formed in the insulating portion.

10. (Previously Presented) The device according to claim 8, wherein the input sensor is bonded to a recessed area formed in the reverse side.

11. (Previously Presented) An electrostatic-capacitance-type coordinate input device according to Claim 1, wherein the reverse surface of the flexible substrate

corresponding to the extension section is bonded to a rear surface of a planar portion of the insulating support plate.

12. (Previously Presented) The device according to claim 8, wherein the reverse surface of the flexible substrate corresponding to the extension section is bonded to a rear surface of a planar portion of the insulating support plate.